

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
1	BRS	L1	146	174/263.ccls. and pad	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 14:51	
2	BRS	L2	47	1 and base	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 14:51	
3	BRS	L3	7	2 and (polyimide adj resin)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:26	
4	BRS	L4	11	("4118595" "4766268" "4840924" "4866507" "5252781" "5258094" "5260518" "5262351" "5317801" "5517756" "5559372").PN.	USPA T	2002/12/06 14:54	
5	IS&R	L5	2	("6225569").PN.	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:33	
6	BRS	L6	6	("3781596" "5134461" "5175609" "5190601" "5635764" "5838069").PN.	USPA T	2002/12/06 15:26	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
7	BRS	L7	6966	174/\$.ccls. and (circuit adj board)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:35	
8	BRS	L8	2776	7 and base	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:35	
9	BRS	L9	33	7 and (base same (polyimide adj resin))	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:45	
10	BRS	L10	94	8 and (polyimide adj resin)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:36	
11	BRS	L11	17	10 and (conductive adj layer)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:45	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
12	BRS	L12	1	11 and (nickel near layer)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:44	
13	BRS	L13	36	("Re26837" "3609547" "3736471" "3953566" "4133592" "4482516" "4530779" "4540229" "4683550" "4705762" "4733461" "4783695" "4840570" "4963225" "4968931" "4985296" "4994735" "5007163" "5252857" "5289631" "5315481" "5366906" "5380210" "5428190" "5432677" "5437556" "5440240" "5461328" "5498467" "5527741" "5541524" "5567657" "5597737" "5602491" "5634267" "5731073").PN.	USPA T	2002/12/06 15:38	
14	BRS	L14	1763	(base same (polyimide adj resin))	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:43	
15	BRS	L15	123	(base near (polyimide adj resin))	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:43	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
16	BRS	L17	0	16 and (nickel near layer)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:45	
17	BRS	L18	188	7 and (polyimide adj resin)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:52	
18	BRS	L20	1	19 and (nickel near layer)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:45	
19	BRS	L16	9	15 and (conductive adj layer)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:51	
20	BRS	L21	4	("5844753" "5857257" "6184479" "6217987").PN.	USPA T	2002/12/06 15:48	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
21	BRS	L22	25	("3356624" "4504607" "4510276" "4615950" "4713298" "4750976" "4752499" "4820549" "4888269" "4902726" "4948700" "4990395" "5009982" "5021472" "5055321" "5055378" "5061744" "5137936" "5175060" "5302492" "5519177" "5532094" "5741575" "5753722" "5948514").PN.	USPA T	2002/12/06 15:50	
22	BRS	L23	899	174/254.ccls.	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:52	
23	BRS	L24	36	23 and (polyimide adj resin)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:52	
24	BRS	L25	12	24 and (conductive adj layer)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 15:53	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
25	BRS	L26	6	25 and nickel	USPAT; EPO; JPO; DER WENT; USOCR	2002/12/06 15:53	
26	BRS	L27	3	("5450286" "6169664" "6233821").PN.	USPAT	2002/12/06 15:54	
27	BRS	L19	39	18 and (conductive adj layer)	USPAT; EPO; JPO; DER WENT; USOCR	2002/12/06 16:44	
28	BRS	L28	9	("5495665" "5598307" "5737837" "5835306" "5879787" "5978177" "6100582" "6162996" "6198052").PN.	USPAT	2002/12/06 15:59	
29	BRS	L29	8	("3726002" "4847136" "4979074" "5305519" "5329423" "5600103" "5943212" "6005777").PN.	USPAT	2002/12/06 16:00	
30	BRS	L30	56	174/261.ccls. and (polyimide adj resin)	USPAT; EPO; JPO; DER WENT; USOCR	2002/12/06 16:56	
31	BRS	L31	55	174/262.ccls. and (polyimide adj resin)	USPAT; EPO; JPO; DER WENT; USOCR	2002/12/06 16:54	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
32	BRS	L32	7	174/267.ccls. and (polyimide adj resin)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 16:55	
33	BRS	L33	1982	7 and terminal	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 16:55	
34	BRS	L34	73	33 and (polyimide adj resin)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 16:59	
35	BRS	L35	8	("3726002" "4847136" "4979074" "5305519" "5329423" "5600103" "5943212" "6005777").PN.	USPA T	2002/12/06 16:59	
36	BRS	L36	22	(polyimide adj resin) near (circuit adj board)	USPA T; EPO; JPO; DER WEN T; USOC R	2002/12/06 17:06	
37	BRS	L37	5	("5108201" "5276133" "5723206" "5858518" "6232428").PN.	USPA T	2002/12/06 17:02	
38	BRS	L38	3	("5470943" "5605763" "5665802").PN.	USPA T	2002/12/06 17:03	
39	BRS	L39	7	5858518.URPN.	USPA T	2002/12/06 17:03	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
40	BRS	L40	461	suspension adj substrate	USPAT; EPO; JPO; DERWENT; USOCR	2002/12/06 17:29	
41	IS&R	L41	2	("5858518").PN.	USPAT; EPO; JPO; DERWENT; USOCR	2002/12/06 17:29	
42	BRS	L42	3	("5470943" "5605763" "5665802").PN.	USPAT	2002/12/06 17:29	
43	BRS	L43	7	5858518.URPN.	USPAT	2002/12/06 17:29	